### 1. General description

The 74LVC2G14 provides two inverting buffers with Schmitt-trigger action.

The inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of this device in a mixed 3.3 V and 5 V environment. Schmitt-trigger action at the inputs makes the circuit tolerant of slower input rise and fall time. This device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

### 2. Features

- Wide supply voltage range from 1.65 V to 5.5 V
- 5 V tolerant inputs for interfacing with 5 V logic
- High noise immunity
- Complies with JEDEC standard:
  - ◆ JESD8-7 (1.65 V to 1.95 V)
  - JESD8-5 (2.3 V to 2.7 V)
  - JESD8B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114E exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- ±24 mA output drive (V<sub>CC</sub> = 3.0 V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Unlimited rise and fall times
- Input accepts voltages up to 5 V
- Multiple package options
- Specified from –40 °C to +85 °C and –40 °C to +125 °C.

## 3. Applications

- Wave and pulse shaper
- Astable multivibrator
- Monostable multivibrator



Dual inverting Schmitt trigger with 5 V tolerant input

## 4. Ordering information

Table 1. Ordering information							
Type number	Package						
	Temperature range	Name	Description	Version			
74LVC2G14GW	–40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363			
74LVC2G14GV	–40 °C to +125 °C	TSOP6	plastic surface-mounted package (TSOP6); 6 leads	SOT457			
74LVC2G14GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1.45 $\times$ 0.5 mm	SOT886			
74LVC2G14GF	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1 $\times$ 0.5 mm	SOT891			

## 5. Marking

Table 2. Marking	
Type number	Marking code
74LVC2G14GW	VK
74LVC2G14GV	V14
74LVC2G14GM	VK
74LVC2G14GF	VK

## 6. Functional diagram



Dual inverting Schmitt trigger with 5 V tolerant input

## 7. Pinning information

### 7.1 Pinning



### 7.2 Pin description

Table 3.   Pin description		
Symbol	Pin	Description
1A	1	data input
GND	2	ground (0 V)
2A	3	data input
2Y	4	data output
V <sub>CC</sub>	5	supply voltage
1Y	6	data input

## 8. Functional description

#### Table 4.Function table

Input	Output
nA	nY
L	Н
Н	L

[1] H = HIGH voltage level;

L = LOW voltage level.

Dual inverting Schmitt trigger with 5 V tolerant input

## 9. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>1</sub> < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
Ι <sub>ΟΚ</sub>	output clamping current	$V_{O}$ > $V_{CC}$ or $V_{O}$ < 0 V	-	±50	mA
Vo	output voltage	Active mode	<u>[1][2]</u> –0.5	$V_{CC} + 0.5$	V
		Power-down mode	<u>[1][2]</u> –0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to $V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	<u>[3]</u> _	250	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] When  $V_{CC}$  = 0 V (Power-down mode), the output voltage can be 5.5 V in normal operation.

## **10. Recommended operating conditions**

#### Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage		1.65	-	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	Active mode	0	-	V <sub>CC</sub>	V
		Power-down mode; $V_{CC} = 0 V$	0	-	5.5	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	°C

Dual inverting Schmitt trigger with 5 V tolerant input

## **11. Static characteristics**

#### Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ 🚹	Max	Unit
T <sub>amb</sub> = -	40 °C to +85 °C					
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
		$I_{O}$ = –100 $\mu A;$ $V_{CC}$ = 1.65 V to 5.5 V	$V_{CC} - 0.1$	-	-	V
		$I_0 = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	V
		$I_0 = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.9	-	-	V
		$I_0 = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	V
		$I_0 = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.3	-	-	V
		$I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.8	-	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$				
		$I_{O}$ = 100 $\mu A; V_{CC}$ = 1.65 V to 5.5 V	-	-	0.1	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.3	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	V
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	V
		$I_0 = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.55	V
lı	input leakage current	$V_{\rm I}$ = 5.5 V or GND; $V_{\rm CC}$ = 0 V to 5.5 V	-	±0.1	±5	μA
I <sub>OFF</sub>	power-off leakage current	$V_{I}$ or $V_{O}$ = 5.5 V; $V_{CC}$ = 0 V	-	±0.1	±10	μA
I <sub>CC</sub>	supply current	$V_{I} = 5.5 V \text{ or GND};$ $V_{CC} = 1.65 V \text{ to } 5.5 V; I_{O} = 0 \text{ A}$	-	0.1	10	μΑ
Δl <sub>CC</sub>	additional supply current		-	5	500	μΑ
Cı	input capacitance	$V_{CC}$ = 3.3 V; $V_I$ = GND to $V_{CC}$	-	3.5	-	pF
T <sub>amb</sub> = -	40 °C to +125 °C					
V <sub>OH</sub>	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O}$ = -100 $\mu$ A; $V_{CC}$ = 1.65 V to 5.5 V	V <sub>CC</sub> – 0.1	-	-	V
		$I_0 = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	0.95	-	-	V
		$I_0 = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.7	-	-	V
		$I_0 = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	1.9	-	-	V
		$I_0 = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.0	-	-	V
		$I_0 = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.4	-	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_0 = 100 \ \mu\text{A}; \ V_{CC} = 1.65 \ V \ to \ 5.5 \ V$	-	-	0.1	V
		I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V	-	-	0.7	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.45	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.6	V
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.8	V
		$I_0 = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.8	V
I	input leakage current	$V_{\rm I} = 5.5$ V or GND; $V_{\rm CC} = 0$ V to 5.5 V	-	-	±20	μA

### Dual inverting Schmitt trigger with 5 V tolerant input

At recom	At recommended operating conditions; voltages are referenced to $GND$ (ground = 0 V).							
Symbol	Parameter	Conditions	Min	Typ 🚹	Max	Unit		
I <sub>OFF</sub>	power-off leakage current	$V_{I}$ or $V_{O}$ = 5.5 V; $V_{CC}$ = 0 V	-	-	±20	μΑ		
I <sub>CC</sub>	supply current	$V_{\rm I}$ = 5.5 V or GND; $V_{\rm CC}$ = 1.65 V to 5.5 V; $I_{\rm O}$ = 0 A	-	-	40	μA		
$\Delta I_{CC}$	additional supply current		-	-	5000	μA		

#### Table 7. Static characteristics ... continued

[1] All typical values are measured at maximum V<sub>CC</sub> and T<sub>amb</sub> = 25 °C.

#### Table 8. Transfer characteristics

Voltages are referenced to GND (ground = 0 V; for test circuit see Figure 8

Symbol	Parameter	Conditions	-40	–40 °C to +85 °C			–40 °C to +125 °C	
			Min	Typ[1]	Max	Min	Max	
$V_{T+}$	positive-going	see Figure 9 and Figure 10	·	·				·
	threshold voltage	V <sub>CC</sub> = 1.8 V	0.70	1.10	1.50	0.70	1.70	V
		$V_{CC} = 2.3 V$	1.00	1.40	1.80	1.00	2.00	V
		$V_{CC} = 3.0 V$	1.30	1.76	2.20	1.30	2.40	V
		$V_{CC} = 4.5 V$	1.90	2.47	3.10	1.90	3.30	V
		$V_{CC} = 5.5 V$	2.20	2.91	3.60	2.20	3.80	V
$V_{T-}$	negative-going threshold voltage	see Figure 9 and Figure 10						
		V <sub>CC</sub> = 1.8 V	0.25	0.61	0.90	0.25	1.10	V
		$V_{CC} = 2.3 V$	0.40	0.80	1.15	0.40	1.35	V
		$V_{CC} = 3.0 V$	0.60	1.04	1.50	0.60	1.70	V
		$V_{CC} = 4.5 V$	1.00	1.55	2.00	1.00	2.20	V
		$V_{CC} = 5.5 V$	1.20	1.86	2.30	1.20	2.50	V
V <sub>H</sub> hysteresis voltage		(V <sub>T+</sub> – V <sub>T</sub> ); see <u>Figure 9,</u> <u>Figure 10</u> and <u>Figure 11</u>						
		V <sub>CC</sub> = 1.8 V	0.15	0.49	1.00	0.15	1.20	V
		$V_{CC} = 2.3 V$	0.25	0.60	1.10	0.25	1.30	V
		$V_{CC} = 3.0 V$	0.40	0.73	1.20	0.40	1.40	V
		$V_{CC} = 4.5 V$	0.60	0.92	1.50	0.60	1.70	V
		$V_{CC} = 5.5 V$	0.70	1.02	1.70	0.70	1.90	V

[1] All typical values are measured at  $T_{amb}$  = 25  $^\circ C$ 

Dual inverting Schmitt trigger with 5 V tolerant input

## **12. Dynamic characteristics**

#### Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions		–40 °C to +85 °C			−40 °C to +125 °C		Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t <sub>pd</sub>	propagation delay	nA to nY; see Figure 7	[2]						
		$V_{CC}$ = 1.65 V to 1.95 V		1.0	5.6	11.0	1.0	12.0	ns
		$V_{CC}$ = 2.3 V to 2.7 V		0.5	3.7	6.5	0.5	7.2	ns
		$V_{CC} = 2.7 V$		0.5	4.1	7.0	0.5	7.7	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		0.5	3.9	6.0	0.5	6.7	ns
		$V_{CC} = 4.5 V \text{ to } 5.5 V$		0.5	2.7	4.3	0.5	4.7	ns
$C_{PD}$	power dissipation capacitance	$V_{\rm I}$ = GND to $V_{CC};V_{CC}$ = 3.3 V	<u>[3]</u>	-	18.1	-	-	-	pF

[1] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.8 V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

[2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[3]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W).

 $\mathsf{P}_{\mathsf{D}} = \mathsf{C}_{\mathsf{P}\mathsf{D}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}{}^2 \times \mathsf{f}_i \times \mathsf{N} + \Sigma(\mathsf{C}_{\mathsf{L}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}{}^2 \times \mathsf{f}_o) \text{ where:}$ 

 $f_i$  = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

 $C_L$  = output load capacitance in pF;

 $V_{CC}$  = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$  = sum of outputs.

## 13. Waveforms



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### Dual inverting Schmitt trigger with 5 V tolerant input

Supply voltage	Input	Output			
V <sub>cc</sub>	V <sub>M</sub>	V <sub>M</sub>			
1.65 V to 1.95 V	$0.5  imes V_{CC}$	$0.5 \times V_{CC}$			
2.3 V to 2.7 V	$0.5  imes V_{CC}$	$0.5 \times V_{CC}$			
2.7 V	1.5 V	1.5 V			
3.0 V to 3.6 V	1.5 V	1.5 V			
4.5 V to 5.5 V	$0.5  imes V_{CC}$	$0.5 \times V_{CC}$			





Test data is given in Table 11.

Definitions for test circuit:

R<sub>L</sub> = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to the output impedance  $Z_0$  of the pulse generator.

 $V_{EXT}$  = External voltage for measuring switching times.

#### Fig 8. Load circuitry for switching times

#### Table 11. Test data

Supply voltage	Input		Load		V <sub>EXT</sub>
V <sub>cc</sub>	VI	$t_r = t_f$	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>
1.65 V to 1.95 V	V <sub>CC</sub>	$\leq$ 2.0 ns	30 pF	1 kΩ	open
2.3 V to 2.7 V	V <sub>CC</sub>	$\leq$ 2.0 ns	30 pF	500 Ω	open
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open
4.5 V to 5.5 V	V <sub>CC</sub>	≤ 2.5 ns	50 pF	500 Ω	open

Dual inverting Schmitt trigger with 5 V tolerant input

## 14. Waveforms transfer characteristics





#### Dual inverting Schmitt trigger with 5 V tolerant input

## **15. Application information**

The slow input rise and fall times cause additional power dissipation, which can be calculated using the following formula:

 $P_{add} = f_i \times (t_r \times \Delta I_{CC(AV)} + t_f \times \Delta I_{CC(AV)}) \times V_{CC}$  where:

 $P_{add}$  = additional power dissipation ( $\mu$ W);

 $f_i = input frequency (MHz);$ 

 $t_r$  = input rise time (ns); 10 % to 90 %;

 $t_f$  = input fall time (ns); 90 % to 10 %;

 $\Delta I_{CC(AV)}$  = average additional supply current (µA).

 $\Delta I_{CC(AV)}$  differs with positive or negative input transitions, as shown in Figure 12.

An example of a relaxation circuit using the 74LVC2G14 is shown in Figure 13.



Linear change of V<sub>1</sub> between 0.8 V to 2.0 V. All values given are typical unless otherwise specified.

- (1) Positive-going edge.
- (2) Negative-going edge.





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Dual inverting Schmitt trigger with 5 V tolerant input

## 16. Package outline



Fig 14. Package outline SOT363 (SC-88)

Dual inverting Schmitt trigger with 5 V tolerant input



Fig 15. Package outline SOT457 (TSOP6)

#### Dual inverting Schmitt trigger with 5 V tolerant input



#### Fig 16. Package outline SOT886 (XSON6)

74LVC2G14\_4 Product data sheet

#### Dual inverting Schmitt trigger with 5 V tolerant input



#### Fig 17. Package outline SOT891 (XSON6)

74LVC2G14\_4 Product data sheet

Dual inverting Schmitt trigger with 5 V tolerant input

## **17. Abbreviations**

Table 12. Abbreviations			
Acronym	Description		
CMOS	Complementary Metal Oxide Semiconductor		
TTL	Transistor-Transistor Logic		
HBM	Human Body Model		
ESD	ElectroStatic Discharge		
MM	Machine Model		
DUT	Device Under Test		

## 18. Revision history

Table 13.	Revision	history
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Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC2G14_4	20070904	Product data sheet		74LVC2G14_3
Modifications:	current.	11 "Static characteristics", ch Package outline SOT891 (XS	C C	put leakage and supply
74LVC2G14_3	20070220	Product data sheet		74LVC2G14_2
74LVC2G14_2	20040908	Product specification	-	74LVC2G14_1
74LVC2G14_1	20030731	Product specification		-

Dual inverting Schmitt trigger with 5 V tolerant input

## **19. Legal information**

### **19.1 Data sheet status**

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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### **NXP Semiconductors**

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